

RoHS

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE ± 0.05)

SPECIFICATIONS

Rated Current:3.0AMP
Contact Resistance:20m Ω Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000M Ω Min
Operation Temperature:-40°c to +105°c

Contact Material:Brass
Contact Plating:Au Over Ni
Insulator Material:Polyester(UL94V-0)
Standard: PA6T
Max.Processing Temp: 230°C for 30-60 seconds
(260°C for 10 seconds)

Dimension antitheses list		
ITEM	PB	PC
Standard	13.5	3.20
Alternate		

Ordering Information

HC-FH485D2- 2 XX X N XX S Y X 01

No.of
Pins
2*2~
2*40P

Insulator Material
Option
A=BK-PBT
C=BK-PA6T
D=BK-PA46
E=BK-PA9T
F=BK-LCP

Post
W=With Post
N=W/O Post

Contact Plating
G0:Gold Flash
G1:3U" Gold
G2:5U" Gold
G3:10U" Gold
G4:15U" Gold
G5:30U" Gold
S0:Gold Flash/Tin
SN:Tin

Packing
A=Tray
T=Tube
R=Reel

Special

OPERATION

X.X ± 0.30

X.XX ± 0.20

X.XXX ± 0.10

Angle $\pm 3^\circ$

DIM TOL

DRAW

Lu jin ying

CHECK

APPROVE

SCALE

FIT

UNIT

mm

SIZE

A4

SHEET

1/1

PROJ.

Φ $\triangleleft$

HECON 东莞市禾康电子有限公司
DONGGUAN HECON ELECTRONICS CO.,LTD

PART NO.

HC-FH485D2-2XXXXNXXSYX01

TITLE:

2.54PF H8.5mm+H2.5+2.5mm 2xNpin
180° W5.0mm

1

2

3

4

5

6

7

8

9

G

F

E

D

C

B

A

G

F

E

D

C

B

A